NCE 60V Complementary MOSFET

Description

The NCE603S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features N channel

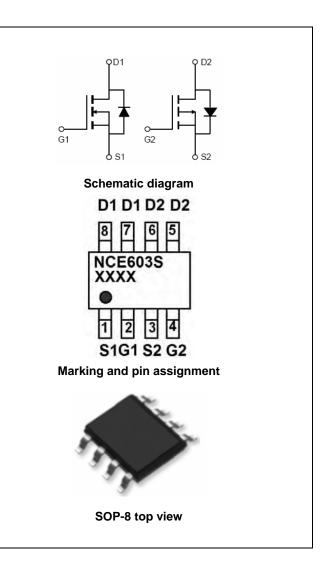
V_{DS} =60V,I_D =6A
 R_{DS(ON)} <60mΩ @ V_{GS}=10V

p channel

- V_{DS} =-60V,I_D =-6A
 R_{DS(ON)} <80mΩ @ V_{GS}=-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- H-bridge
- Inverters



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE603S	NCE603S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25°Cunless otherwise noted)

Parame	Symbol	N-Channel	P-Channel	Unit			
Drain-Source Voltage	V _{DS}	60	-60	V			
Gate-Source Voltage		V _{GS}	±20	±20	V		
Continuous Drain Current	T _C =25℃		6	-6	^		
	Tc=100℃	I _D	4.2	-4.2	A		
Pulsed Drain Current (Note 1)		I _{DM}	30	-30	А		
Maximum Power Dissipation	T _C =25℃	PD	2	2	W		
Operating Junction and Storage T	TJ,TSTG	-55 To 175	-55 To 175	°C			
Thermal Characteristic							
N-channel	Thermal Resistance, Ju	²⁾ R _{θJA}	75	°C/W			
P-channel	Thermal Resistance, Ju	²⁾ R _{θJA}	50	°C/W			

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	s V _{DS} =60V,V _{GS} =0V		-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.0	2.0	3.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =6A	-	37	44	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =6A	11	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	<u>)</u> 20)/)/ 0)/	-	450	-	PF
Output Capacitance	C _{oss}	V _{DS} =30V,V _{GS} =0V, F=1.0MHz	-	61	-	PF
Reverse Transfer Capacitance	C _{rss}		-	27	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	4.2	-	nS
Turn-on Rise Time	tr	V_{DD} =30V ,R _L =2.5 Ω	-	3.4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	16	-	nS
Turn-Off Fall Time	t _f		-	2	-	nS
Total Gate Charge	Qg	V _20V/L_6A	-	10		nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =6A, V _{GS} =10V	-	2.4		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	3.6		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	6	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =6A	-	27	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3) - 30 -		-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				

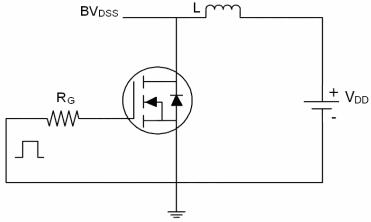
N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

Notes:

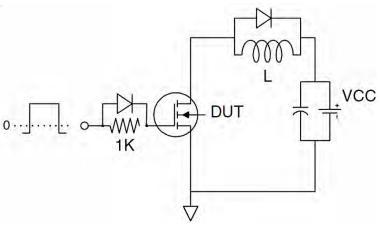
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

Test Circuit

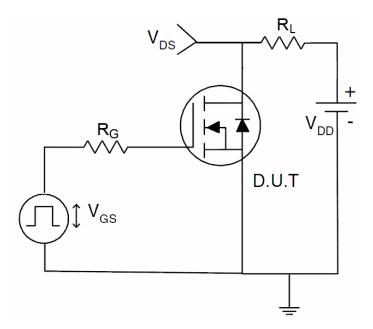
1) E_{AS} test Circuit

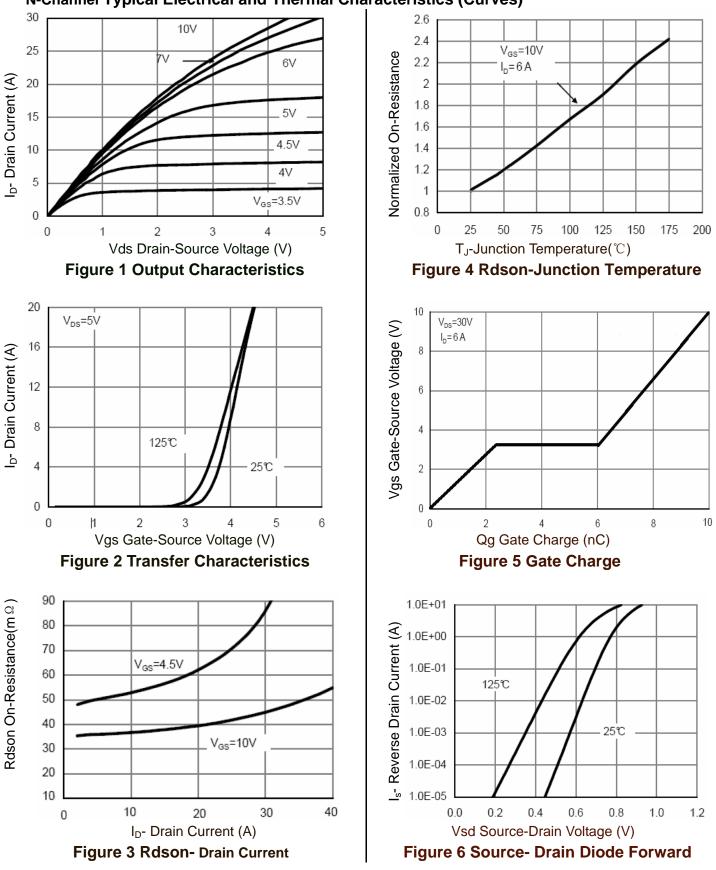


2) Gate charge test Circuit

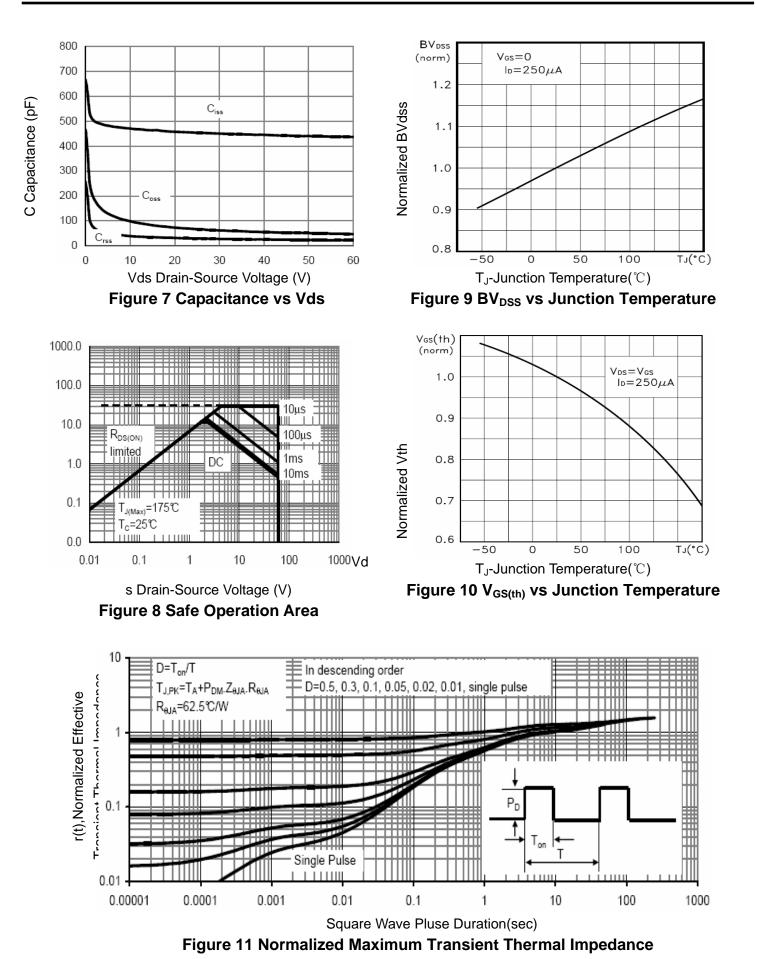


3) Switch Time Test Circuit





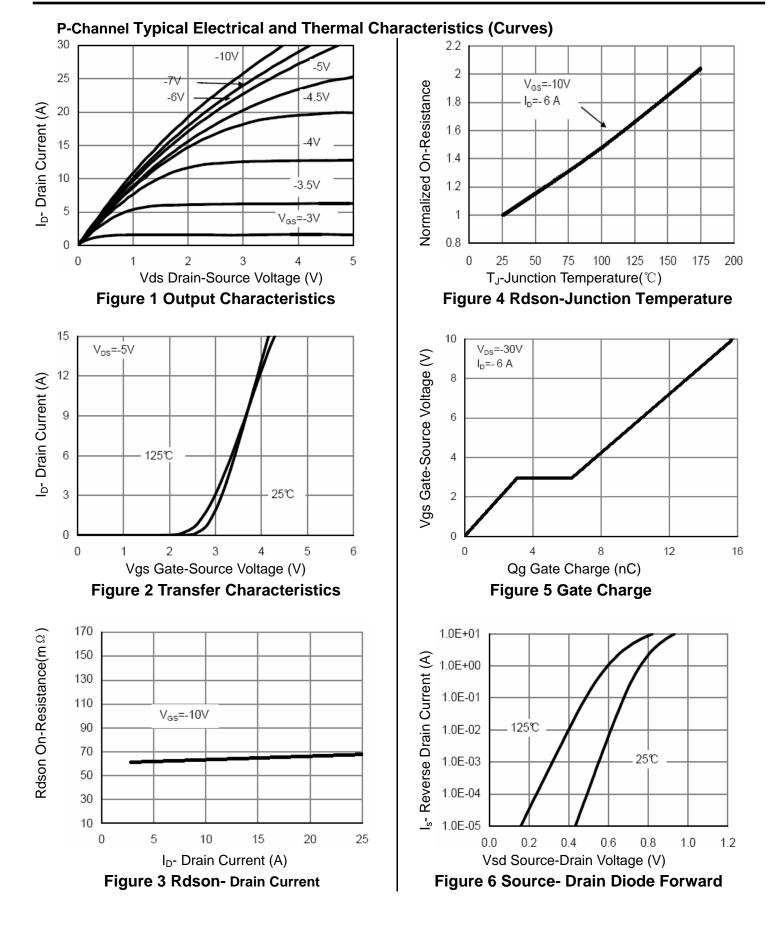
N-Channel Typical Electrical and Thermal Characteristics (Curves)

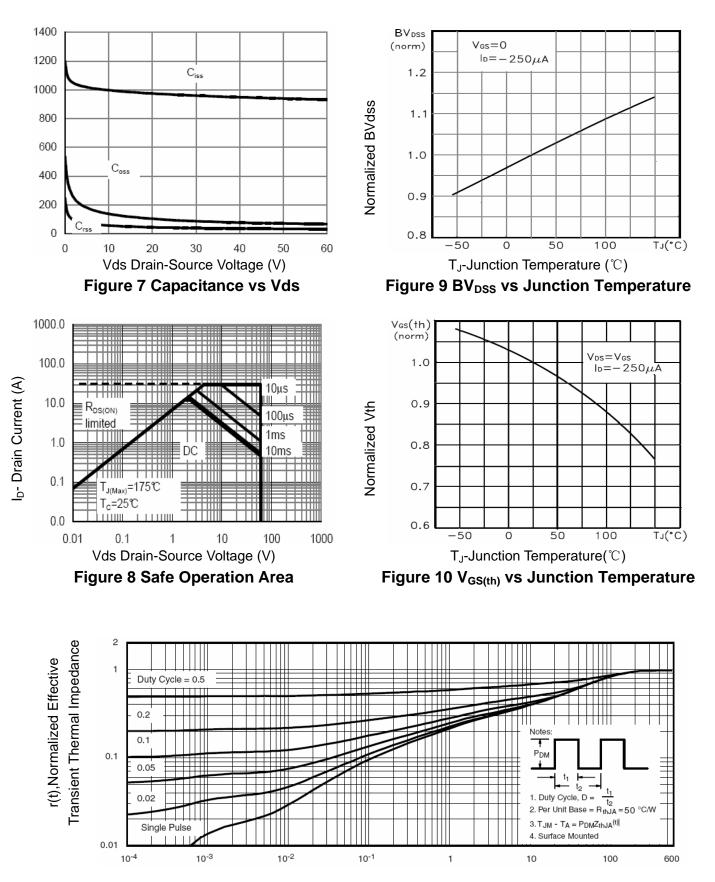


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Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	I _{DSS} V _{DS} =-60V,V _{GS} =0V		-	-1	μA
Gate-Body Leakage Current		V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·	·				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.5	-2.6	-3.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-6A	-	64	80	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-6A	11	-	-	S
Dynamic Characteristics (Note4)	·	·				
Input Capacitance	C _{lss}		-	960	-	PF
Output Capacitance	C _{oss}	V _{DS} =-30V,V _{GS} =0V, F=1.0MHz	-	86	-	PF
Reverse Transfer Capacitance	C _{rss}		-	38	-	PF
Switching Characteristics (Note 4)	·	·				
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	tr	V_{DD} =-30V ,R _L =2.5 Ω	-	10	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{G} =3 Ω	-	25	-	nS
Turn-Off Fall Time	t _f		-	11	-	nS
Total Gate Charge	Qg	V 20V/I 6A	-	15.8		nC
Gate-Source Charge	Q _{gs}	V _{DS} =-30V,I _D =-6A, V _{GS} =10V	-	3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	3.5		nC
Drain-Source Diode Characteristics		·				
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-6A	-		-1.2	V
Diode Forward Current (Note 2)	I _S		-	-	-6	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-6A	-	27.5	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3) - 30 -			-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LE				

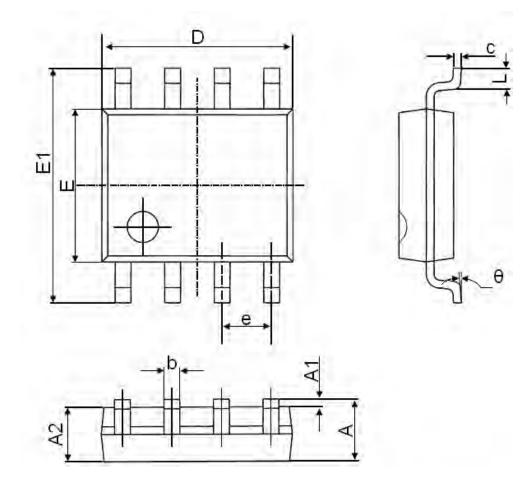
P-Channel Electrical Characteristics (T_c=25[°]C unless otherwise noted)





Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0 °	8 °	0 °	8 °	

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